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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, EBI/EMI, SCI, Serial I/O, UART/USART
Peripherals	POR, WDT
Number of I/O	81
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90f549pf-g

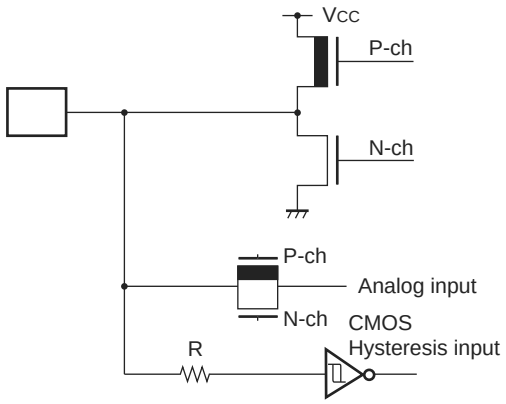
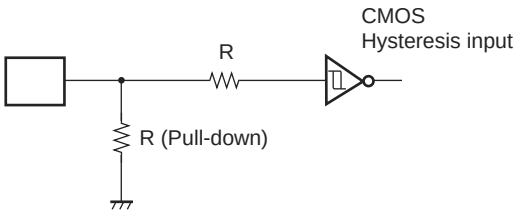
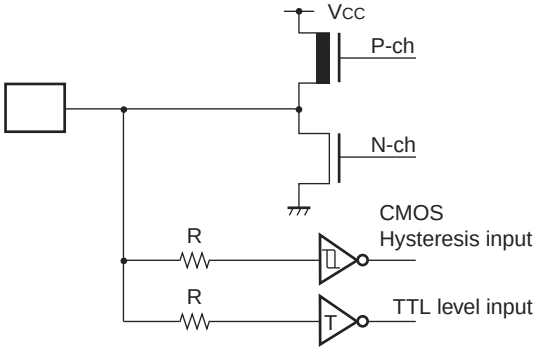
*2 : It is setting of DIP switch S2 when Emulation pod (MB2145-507) is used.Please refer to the MB2145-507 hardware manual (2.7 Emulator-specific Power Pin) about details.

*3 : Operating Voltage Range

Products	Operation guarantee range
MB90F543G(S)/F546G(S)/F548G(S)/ MB90549G(S)/F549G(S)/V540/V540G	4.5 V to 5.5 V
MB90F548GL(S)/543G(S)/547G(S)/548G(S)	3.5 V to 5.5 V

Pin No.		Pin name	Circuit type	Function
LQFP*2	QFP*1			
20	22	P44	G	General I/O port. This function is enabled when UART1 disables the clock output.
		SCK1		Serial clock pulse I/O pin for UART1. This function is enabled when UART1 enables the serial clock output.
22	24	P45	G	General I/O port. This function is enabled when UART1 disables the serial data output.
		SOT1		Serial data output pin for UART1. This function is enabled when UART1 enables the serial data output.
23	25	P46	G	General I/O port. This function is enabled when the Extended I/O serial interface disables the serial data output.
		SOT2		Serial data output pin for the Extended I/O serial interface. This function is enabled when the Extended I/O serial interface enables the serial data output.
24	26	P47	G	General I/O port. This function is enabled when the Extended I/O serial interface disables the clock output.
		SCK2		Serial clock pulse I/O pin for the Extended I/O serial interface . This function is enabled when the Extended I/O serial interface enables the Serial clock output.
26	28	P50	D	General I/O port. This function is always enabled.
		SIN2		Serial data input pin for the Extended I/O serial interface . Set the corresponding Port Direction Register to input if this function is used.
27 to 30	29 to 32	P51 to P54	D	General I/O port. This function is always enabled.
		INT4 to INT7		External interrupt request input pins for INT4 to INT7. Set the corresponding Port Direction Register to input if this function is used.
31	33	P55	D	General I/O port. This function is always enabled.
		ADTG		Trigger input pin for the A/D converter. Set the corresponding Port Direction Register to input if this function is used.
36 to 39	38 to 41	P60 to P63	E	General I/O port. This function is enabled when the analog input enable register specifies a port.
		AN0 to AN3		Analog input pins for the 8/10-bit A/D converter. This function is enabled when the analog input enable register specifies A/D.
41 to 44	43 to 46	P64 to P67	E	General I/O port. The function is enabled when the analog input enable register specifies a port.
		AN4 to AN7		Analog input pins for the 8/10-bit A/D converter. This function is enabled when the analog input enable register specifies A/D.
45	47	P56	D	General I/O port. This function is always enabled.
		TIN0		Event input pin for the 16-bit reload timers 0. Set the corresponding Port Direction Register to input if this function is used.

(Continued)

Circuit type	Diagram	Remarks
E		■ CMOS level output ■ CMOS Hysteresis input ■ Analog input
F		■ CMOS Hysteresis input ■ Pull-down Resistor : 50 kΩ approx. (except Flash devices)
G		■ CMOS level output ■ CMOS Hysteresis input ■ TTL level input (Flash devices in Flash writer mode only)

(Continued)

(6) Pull-up/down resistors

The MB90540G/545G Series does not support internal pull-up/down resistors (except Port0 − Port3 : pull-up resistors) . Use external components where needed.

(7) Crystal Oscillator Circuit

Noises around X0 or X1 pins may be possible causes of abnormal operations. Make sure to provide bypass capacitors via the shortest distances from X0, X1 pins, crystal oscillator (or ceramic resonator) and ground lines, and make sure, to the utmost effort, that lines of oscillation circuits do not cross the lines of other circuits.

It is highly recommended to provide a printed circuit board artwork surrounding X0 and X1 pins with a ground area for stabilizing the operation.

(8) Turning-on Sequence of Power Supply to A/D Converter and Analog Inputs

Make sure to turn on the A/D converter power supply (AV_{CC}, AVRH, AVRL) and analog inputs (AN0 to AN7) after turning-on the digital power supply (V_{CC}) .

Turn-off the digital power after turning off the A/D converter supply and analog inputs. In this case, make sure that the voltage does not exceed AVRH or AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable) .

(9) Connection of Unused Pins of A/D Converter

Connect unused pins of A/D converter to $AV_{CC} = V_{CC}$, $AV_{SS} = AVRH = V_{SS}$.

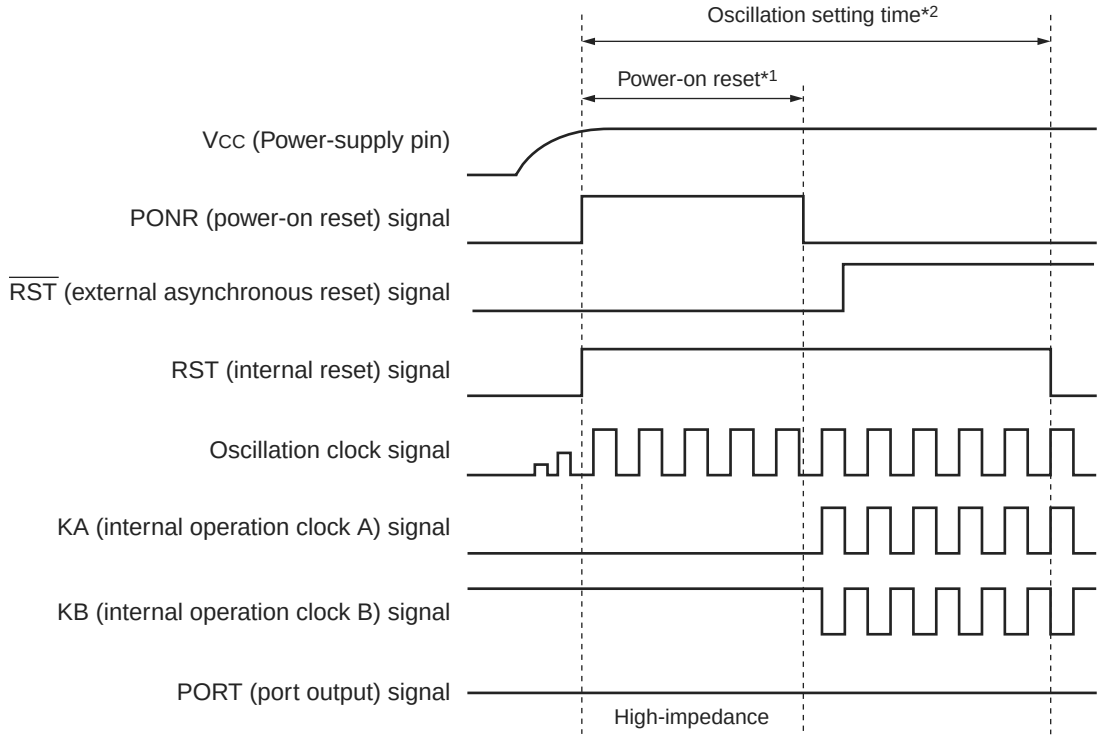
(10) N.C. Pin

The N.C. (internally connected) pin must be opened for use.

(11) Notes on Energization

To prevent the internal regulator circuit from malfunctioning, set the voltage rise time during energization at 50 μs or more (0.2 V to 2.7 V) .

■ $\overline{\text{RST}}$ pin is “L”



*1 : Power-on reset time : “Period of clock frequency” × 2^{17} (Clock frequency of 16 MHz : 8.19 ms)

*2 : Oscillation setting time : “Period of clock frequency” × 2^{18} (Clock frequency of 16 MHz : 16.38 ms)

(13) Initialization

In the device, there are internal registers which are initialized only by a power-on reset. To initialize these registers, please turn on the power again.

(14) Directions of “DIV A, Ri” and “DIVW A, RWi” instructions

In the Signed multiplication and division instructions (“DIV A, Ri” and “DIVW A, RWi”) , the value of the corresponding bank register (DTB, ADB, USB, SSB) is set in “00_H”.

If the values of the corresponding bank registers (DTB, ADB, USB, SSB) are set to other than “00_H”, the remainder by the execution result of the instruction is not stored in the register of the instruction operand.

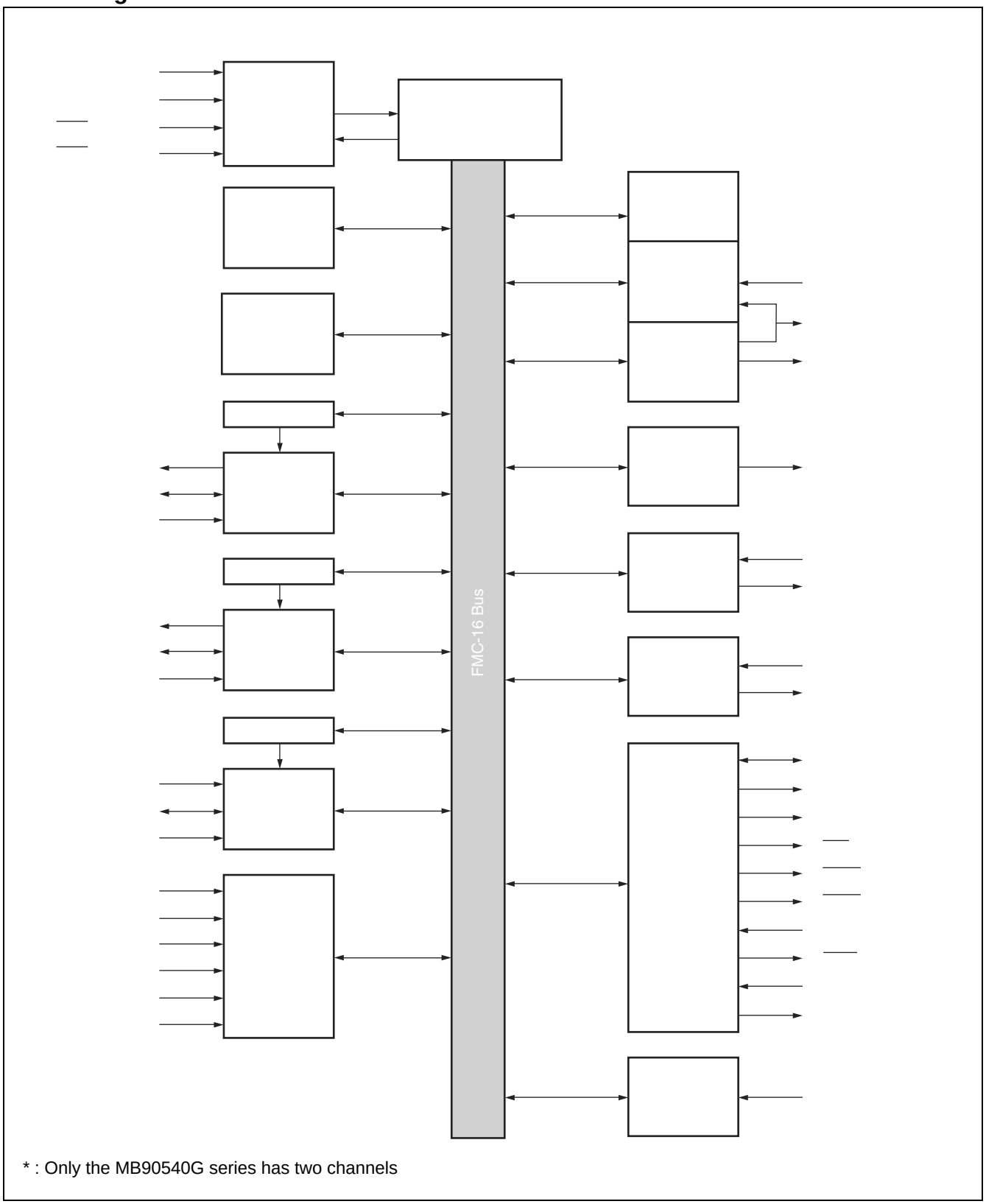
(15) Using REALOS

The use of EI²OS is not possible with the REALOS real time operating system.

(16) Caution on Operations during PLL Clock Mode

If the PLL clock mode is selected, the microcontroller attempt to be working with the self-oscillating circuit even when there is no external oscillator or external clock input is stopped. Performance of this operation, however, cannot be guaranteed.

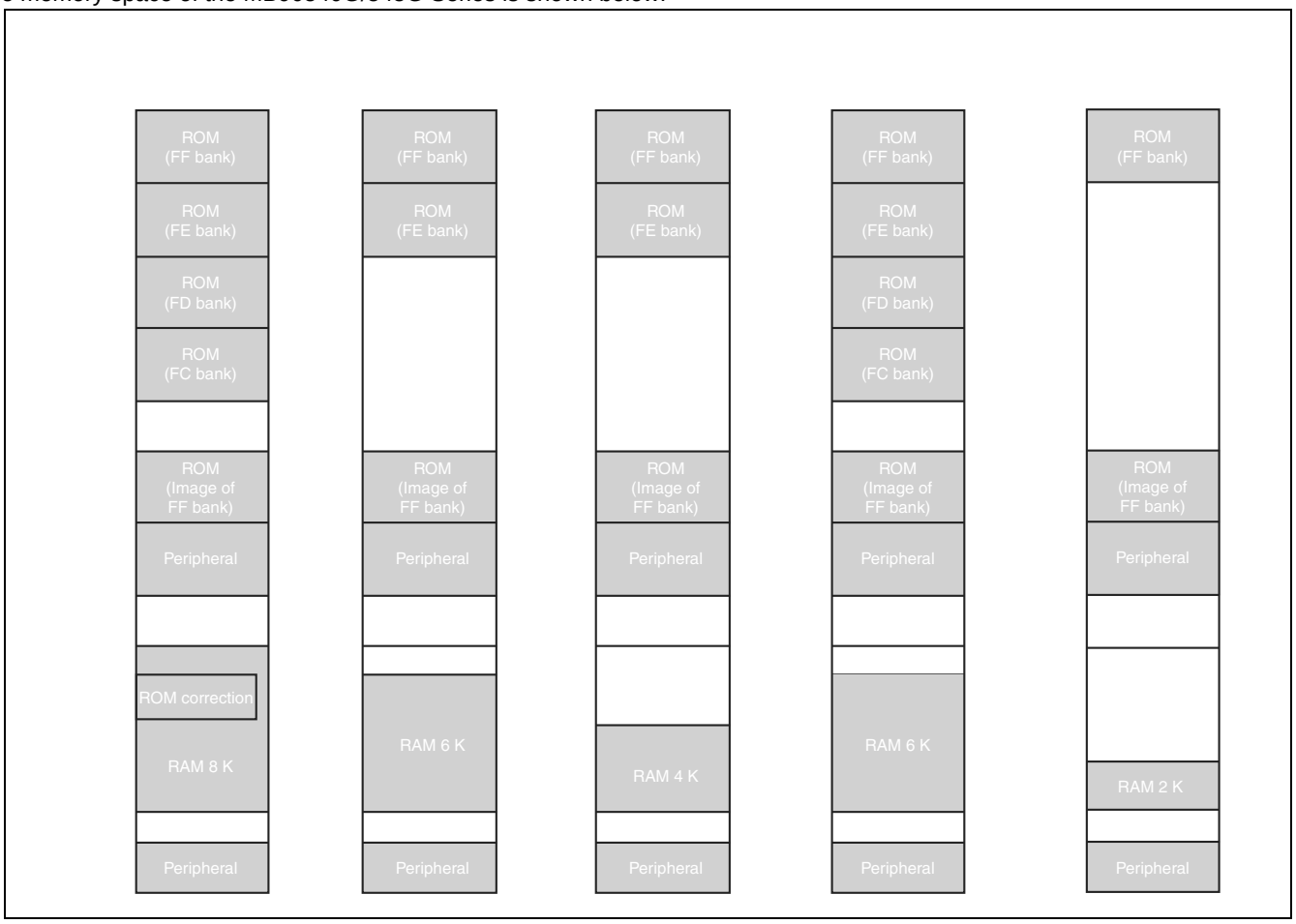
6. Block Diagram



* : Only the MB90540G series has two channels

7. Memory Map

The memory space of the MB90540G/545G Series is shown below.



Note : The high-order portion of bank 00 gives the image of the FF bank ROM to make the small model of the C compiler effective. Since the low-order 16 bits address are the same, the table in ROM can be referenced without using the “far” specification in the pointer declaration.
For example, an attempt to access $00C000_H$ accesses the value at $FFC000_H$ in ROM.The ROM area in bank FF exceeds 48 Kbytes, and its entire image cannot be shown in bank 00.The image between $FF4000_H$ and $FFFFFF_H$ is visible in bank 00, while the image between $FF0000_H$ and $FF3FFF_H$ is visible only in bank FF.

Address	Register	Abbreviation	Access	Resource name	Initial value
47_H to $4B_H$	Prohibited				
$4C_H$	Input capture control status register 0/1	ICS01	R/W	Input Capture 0/1	0 0 0 0 0 0 0 0_B
$4D_H$	Input capture control status register 2/3	ICS23	R/W	Input Capture 2/3	0 0 0 0 0 0 0 0_B
$4E_H$	Input capture control status register 4/5	ICS45	R/W	Input Capture 4/5	0 0 0 0 0 0 0 0_B
$4F_H$	Input capture control status register 6/7	ICS67	R/W	Input Capture 6/7	0 0 0 0 0 0 0 0_B
50_H	Timer control status register 0	TMCSR0	R/W	16-bit Reload Timer 0	0 0 0 0 0 0 0 0_B
51_H	Timer control status register 0	TMCSR0	R/W		_ _ _ _ 0 0 0 0_B
52_H	Timer register 0/reload register 0	TMR0/TMRLR0	R/W		XXXXXXXX_B
53_H	Timer register 0/reload register 0	TMR0/TMRLR0	R/W		XXXXXXXX_B
54_H	Timer control status register 1	TMCSR1	R/W	16-bit Reload Timer 1	0 0 0 0 0 0 0 0_B
55_H	Timer control status register 1	TMCSR1	R/W		_ _ _ _ 0 0 0 0_B
56_H	Timer register 1/reload register 1	TMR1/TMRLR1	R/W		XXXXXXXX_B
57_H	Timer register 1/reload register 1	TMR1/TMRLR1	R/W		XXXXXXXX_B
58_H	Output compare control status register 0	OCS0	R/W	Output Compare 0/1	0 0 0 0 _ _ 0 0_B
59_H	Output compare control status register 1	OCS1	R/W		_ _ _ 0 0 0 0 0_B
$5A_H$	Output compare control status register 2	OCS2	R/W	Output Compare 2/3	0 0 0 0 _ _ 0 0_B
$5B_H$	Output compare control status register 3	OCS3	R/W		_ _ _ 0 0 0 0 0_B
$5C_H$ to $6B_H$	Prohibited				
$6C_H$	Timer Data register	TCDT	R/W	I/O Timer	0 0 0 0 0 0 0 0_B
$6D_H$	Timer Data register	TCDT	R/W		0 0 0 0 0 0 0 0_B
$6E_H$	Timer Control register	TCCS	R/W		0 0 0 0 0 0 0 0_B
$6F_H$	ROM mirror function selection register	ROMM	R/W	ROM Mirror	_ _ _ _ _ _ _ 1_B
70_H to $7F_H$	Reserved for CAN 0 Interface.				
80_H to $8F_H$	Reserved for CAN 1 Interface.				
90_H to $9D_H$	Prohibited				
$9E_H$	Program address detection control status register	PACSR	R/W	Address Match Detection Function	0 0 0 0 0 0 0 0_B
$9F_H$	Delayed interrupt/release register	DIRR	R/W	Delayed Interrupt	_ _ _ _ _ _ _ 0_B
$A0_H$	Low-power mode control register	LPMCR	R/W	Low Power Controller	0 0 0 1 1 0 0 0_B
$A1_H$	Clock selection register	CKSCR	R/W	Low Power Controller	1 1 1 1 1 1 0 0_B

(Continued)

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Address	Register	Abbreviation	Access	Resource name	Initial value
3928H	Output Compare Register 0	OCCP0	R/W	Output Compare 0/1	XXXXXXXXB
3929H	Output Compare Register 0	OCCP0	R/W		XXXXXXXXB
392AH	Output Compare Register 1	OCCP1	R/W		XXXXXXXXB
392BH	Output Compare Register 1	OCCP1	R/W		XXXXXXXXB
392CH	Output Compare Register 2	OCCP2	R/W	Output Compare 2/3	XXXXXXXXB
392DH	Output Compare Register 2	OCCP2	R/W		XXXXXXXXB
392EH	Output Compare Register 3	OCCP3	R/W		XXXXXXXXB
392FH	Output Compare Register 3	OCCP3	R/W		XXXXXXXXB
3930H to 39FFH	Reserved				
3A00H to 3AFFH	Reserved for CAN 0 Interface.				
3B00H to 3BFFH	Reserved for CAN 0 Interface.				
3C00H to 3CFFH	Reserved for CAN 1 Interface.				
3D00H to 3DFFH	Reserved for CAN 1 Interface.				
3E00H to 3FFFH	Reserved				

- Read/write notation
  - R/W : Reading and writing permitted
  - R : Read-only
  - W : Write-only

- Initial value notation
  - 0 : Initial value is “0”.
  - 1 : Initial value is “1”.
  - X : Initial value is undefined.
  - _ : Initial value is unused.

Note: Any write access to reserved addresses in I/O map should not be performed. A read access to reserved addresses results in reading “X”.

11.3 DC Characteristics

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

Parameter	Symbol	Pin name	Condition	Value			Units	Remarks
				Min	Typ	Max		
Input H voltage	V_{IHS}	CMOS hysteresis input pin	−	0.8 V_{CC}	−	V_{CC} + 0.3	V	
	V_{IH}	TTL input pin	−	2.0	−	−	V	
	V_{IHM}	MD input pin	−	V_{CC} − 0.3	−	V_{CC} + 0.3	V	
Input L voltage	V_{ILS}	CMOS hysteresis input pin	−	V_{CC} − 0.3	−	0.2 V_{CC}	V	
	V_{IL}	TTL input pin	−	−	−	0.8	V	
	V_{ILM}	MD input pin	−	V_{SS} − 0.3	−	V_{SS} + 0.3	V	
Output H voltage	V_{OH}	All output pins	V_{CC} = 4.5 V, I_{OH} = −4.0 mA	V_{CC} − 0.5	−	−	V	
Output L voltage	V_{OL}	All output pins	V_{CC} = 4.5 V, I_{OL} = 4.0 mA	−	−	0.4	V	
Input leak current	I_{IL}	−	V_{CC} = 5.5 V, V_{SS} < V_I < V_{CC}	−5	−	5	µA	
Pull-up resistance	R_{UP}	P00 to P07, P10 to P17, P20 to P27, P30 to P37, RST	−	25	50	100	kΩ	
Pull-down resistance	R_{DOWN}	MD2	−	25	50	100	kΩ	Except Flash devices

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11.4 AC Characteristics

11.4.1 Clock Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

Parameter	Symbol	Pin name	Value			Units	Remarks
			Min	Typ	Max		
Oscillation frequency	f_C	X0, X1	3	—	16	MHz	No multiplier When using an oscillator circuit V_{CC} = 5.0 V ± 10%
			8	—	16	MHz	PLL multiplied by 1 When using an oscillator circuit V_{CC} = 5.0 V ± 10%
			4	—	8	MHz	PLL multiplied by 2 When using an oscillator circuit V_{CC} = 5.0 V ± 10%
			3	—	5.33	MHz	PLL multiplied by 3 When using an oscillator circuit V_{CC} = 5.0 V ± 10%
			3	—	4	MHz	PLL multiplied by 4 When using an oscillator circuit V_{CC} = 5.0 V ± 10%
			3	—	5	MHz	When using an oscillator circuit V_{CC} < 4.5 V(MB90F548GL(S)/543G(S)/547G(S)/548G(S))
			3	—	16	MHz	No multiplier When using an external clock
			8	—	16	MHz	PLL multiplied by 1 When using an external clock
			4	—	8	MHz	PLL multiplied by 2 When using an external clock
			3	—	5.33	MHz	PLL multiplied by 3 When using an external clock
			3	—	4	MHz	PLL multiplied by 4 When using an external clock
	f_{CL}	X0A, X1A	—	32.768	—	kHz	

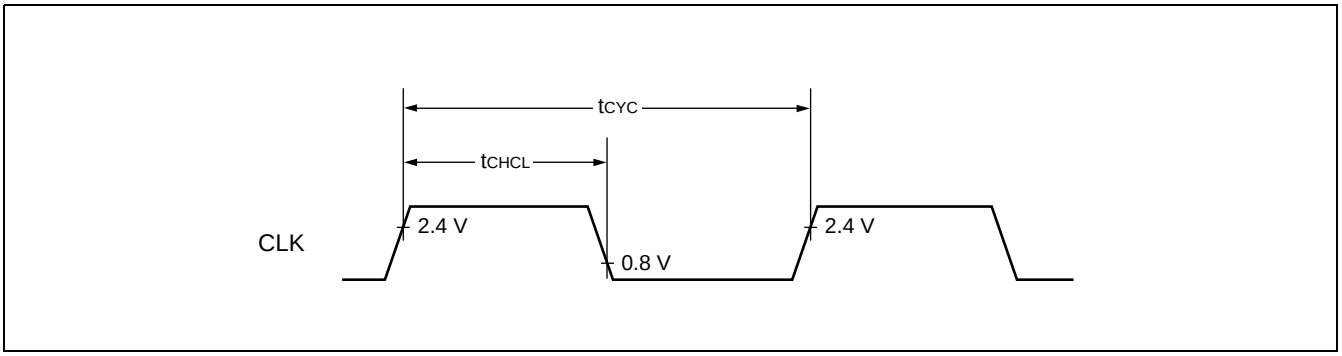
(Continued)

11.4.2 Clock Output Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
Cycle time	t_{CYC}	CLK	V_{CC} = 5 V ± 10%	62.5	—	ns	
CLK↑ → CLK↓	t_{CHCL}			20	—	ns	



11.4.3 Reset and Hardware Standby Input Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +105 °C)

Parameter	Symbol	Pin name	Value		Units	Remarks
			Min	Max		
Reset input time	t_{RSTL}	$\overline{RST}$	4 t_{CP}	—	ns	Under normal operation
			Oscillation time of oscillator + 4 t_{CP}	—	ms	In stop mode
			100	—	µs	In pseudo timer mode (MB90543G (S) /547G (S) /548G (S))
			4 t_{CP}	—	ns	In pseudo timer mode (Other than MB90543G (S) /547G (S) /548G (S))
			2 t_{LCP}	—	µs	In sub-clock mode, sub-sleep mode, timer mode
Hardware standby input time	t_{HSTL}	$\overline{HST}$	4 t_{CP}	—	ns	Under normal operation

Note : "t_{cp}" represents one cycle time of the machine clock.

Oscillation time of oscillator is time that amplitude reached the 90%. In the crystal oscillator, the oscillation time is between several ms to tens of ms. In ceramic oscillator, the oscillation time is between handreds of µs to several ms. In the external clock, the oscillation time is 0 ns.

Any reset can not fully initialize the Flash Memory if it is performing the automatic algorithm.

11.4.4 Power On Reset

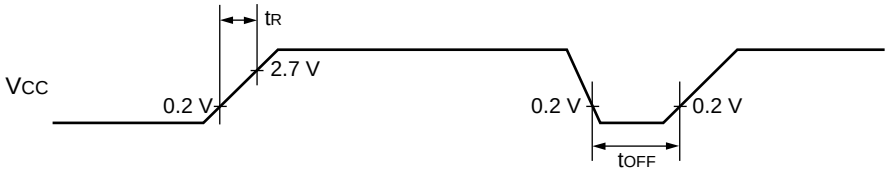
(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

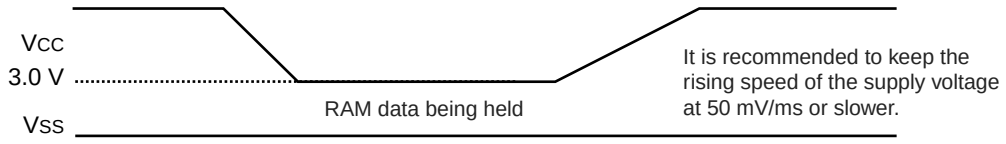
Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
Power on rise time	t_R	V_{CC}	—	0.05	30	ms	*
Power off time	t_{OFF}	V_{CC}		50	—	ms	Waiting time until power-on

* : V_{CC} must be kept lower than 0.2 V before power-on.

Notes : ■ The above values are used for creating a power-on reset.
■ Some registers in the device are initialized only upon a power-on reset. To initialize these register, turn on the power supply using the above values.



Sudden changes in the power supply voltage may cause a power-on reset.
To change the power supply voltage while the device is in operation, it is recommended to raise the voltage smoothly to suppress fluctuations as shown below.
In this case, change the supply voltage with the PLL clock not used. If the voltage drop is 1 V or fewer per second, however, you can use the PLL clock.



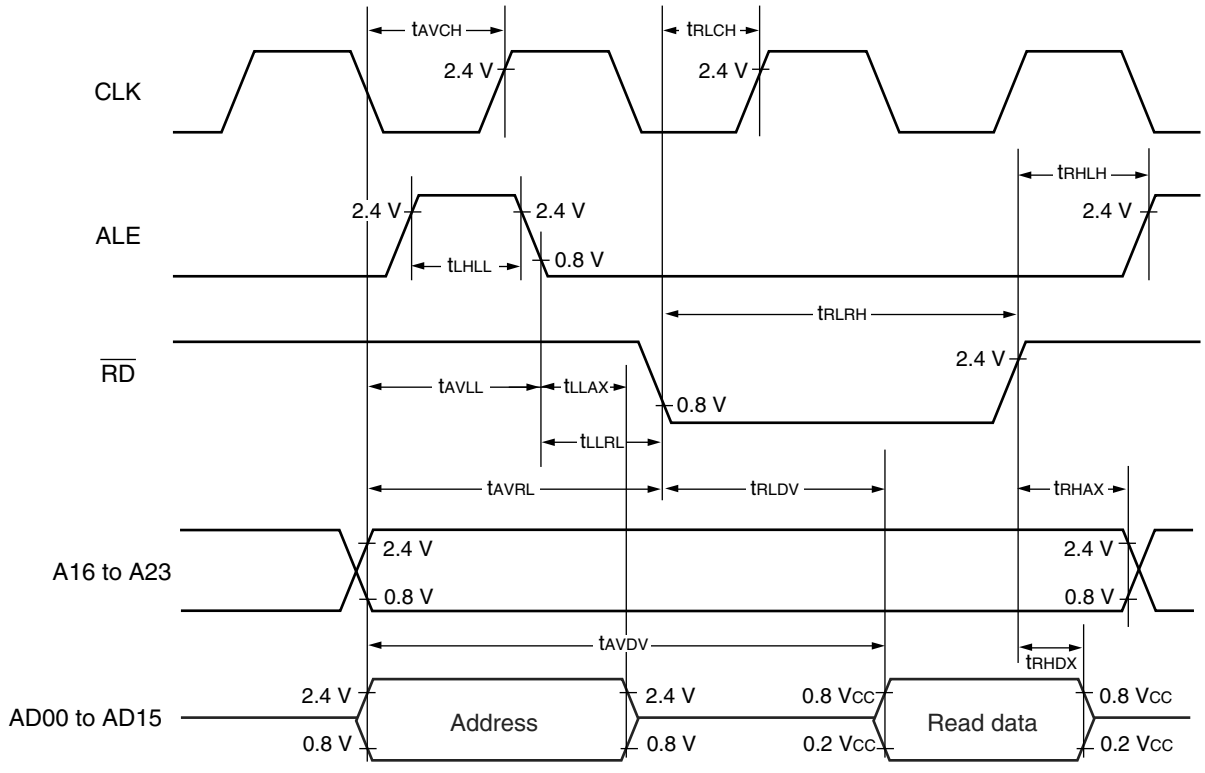
11.4.5 Bus Timing (Read)

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
ALE pulse width	t_{LHLL}	ALE		$t_{CP}/2 - 20$	−	ns	
Valid address → ALE↓ time	t_{AVLL}	ALE, A16 to A23, AD00 to AD15		$t_{CP}/2 - 20$	−	ns	
ALE↓ → Address valid time	t_{LLAX}	ALE, AD00 to AD15		$t_{CP}/2 - 15$	−	ns	
Valid address → $\overline{RD}$↓ time	t_{AVRL}	A16 toA23, AD00 to AD15, $\overline{RD}$		$t_{CP} - 15$	−	ns	
Valid address → Valid data input	t_{AVDV}	A16 to A23, AD00 to AD15		−	$5\ t_{CP}/2 - 60$	ns	
$\overline{RD}$ pulse width	t_{RLRH}	RD	−	$3\ t_{CP}/2 - 20$	−	ns	
$\overline{RD}$↓ → Valid data input	t_{RLDV}	$\overline{RD}$, AD00 to AD15		−	$3\ t_{CP}/2 - 60$	ns	
$\overline{RD}$↑ → Data hold time	t_{RHDX}	$\overline{RD}$, AD00 to AD15		0	−	ns	
$\overline{RD}$↑ → ALE↑ time	t_{RHLH}	$\overline{RD}$, ALE		$t_{CP}/2 - 15$	−	ns	
$\overline{RD}$↑ → Address valid time	t_{RHAX}	$\overline{RD}$, A16 to A23		$t_{CP}/2 - 10$	−	ns	
Valid address → CLK↑ time	t_{AVCH}	A16 to A23, AD00 to AD15, CLK		$t_{CP}/2 - 20$	−	ns	
$\overline{RD}$↓ → CLK↑ time	t_{RLCH}	$\overline{RD}$, CLK		$t_{CP}/2 - 20$	−	ns	
ALE↓ → $\overline{RD}$↓ time	t_{LLRL}	ALE, $\overline{RD}$		$t_{CP}/2 - 15$	−	ns	

■ **Bus Timing (Read)**



11.4.7 Ready Input Timing

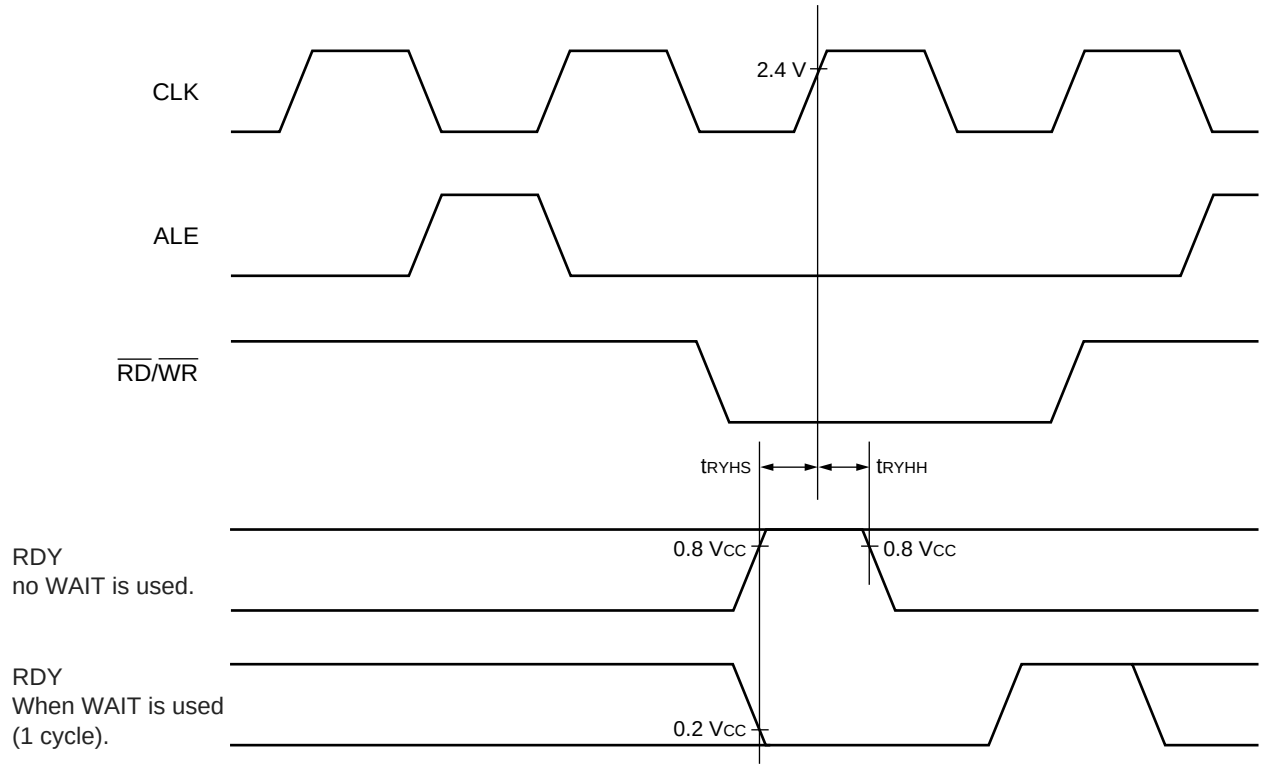
(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
RDY setup time	t_{RYHS}	RDY	—	45	—	ns	
RDY hold time	t_{RYHH}	RDY		0	—	ns	

Note : If the RDY setup time is insufficient, use the auto-ready function.

■ **Ready Input Timing**



11.5 A/D Converter

11.5.1 Electrical Characteristics

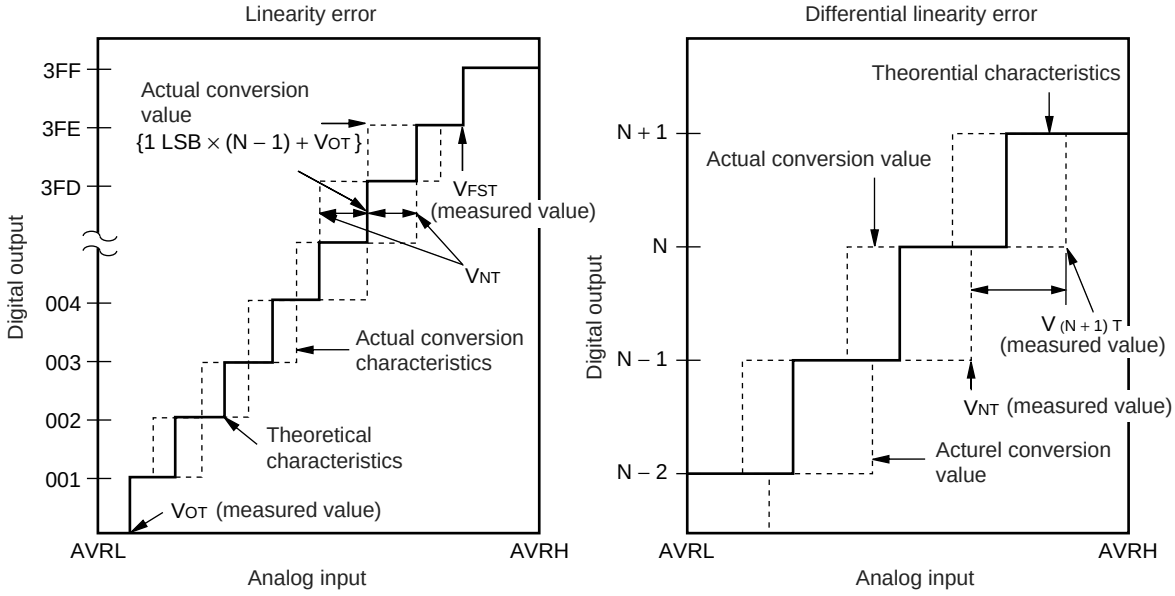
($V_{CC} = AV_{CC} = 5.0\ V \pm 10\%$, $V_{SS} = AV_{SS} = 0.0\ V$, $3.0\ V \leq AVRH - AVRL$, $T_A = -40\ °C$ to $+105\ °C$)

Parameter	Symbol	Pin name	Value			Units	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Conversion error	—	—	—	—	±5.0	LSB	
Nonlinearity error	—	—	—	—	±2.5	LSB	
Differential nonlinearity error	—	—	—	—	±1.9	LSB	
Zero transition voltage	V_{OT}	AN0 to AN7	AVRL − 3.5 LSB	AVRL + 0.5 LSB	AVRL + 4.5 LSB	V	
Full scale transition voltage	V_{FST}	AN0 to AN7	AVRH − 6.5 LSB	AVRH − 1.5 LSB	AVRH + 1.5 LSB	V	
Compare time	—	—	352 t_{CP}	—	—	ns	Internal frequency : 16 MHz
Sampling time	—	—	64 t_{CP}	—	—	ns	Internal frequency : 16 MHz
Analog port input current	I_{AIN}	AN0 to AN7	−1	—	1	µA	$V_{CC} = AV_{CC} = 5.0\ V \pm 1\%$
Analog input voltage range	V_{AIN}	AN0 to AN7	AVRL	—	AVRH	V	
Reference voltage range	—	AVRH	AVRL + 2.7	—	AV_{CC}	V	
	—	AVRL	0	—	AVRH − 2.7	V	
Power supply current	I_A	AV_{CC}	—	5	—	mA	
	I_{AH}	AV_{CC}	—	—	5	µA	*
Reference voltage supply current	I_R	AVRH	—	400	600	µA	Flash device
			—	140	260	µA	MASK ROM
	I_{RH}	AVRH	—	—	5	µA	*
Offset between input channels	—	AN0 to AN7	—	—	4	LSB	

* : When not using an A/D converter, this is the current ($V_{CC} = AV_{CC} = AVRH = 5.0\ V$) when the CPU is stopped.

Note: The functionality of the A/D converter is only guaranteed for VCC = 5.0 V ± 10 % (also for MB90543G(S)/547G(S)/548G(S)/F548G(S)/F548GL(S)).

(Continued)



$$\text{Linearity error of digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (N-1) + V_{OT}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

$$\text{Differential linearity error of digital N} = \frac{V_{(N+1)T} - V_{NT}}{1\ \text{LSB}} - 1\ \text{LSB}\ [\text{LSB}]$$

$$1\ \text{LSB} = \frac{V_{FST} - V_{OT}}{1022}\ [\text{V}]$$

V_{OT} : Voltage at transition of digital output from "000_H" to "001_H"
V_{FST} : Voltage at transition of digital output from "$3FE_H$" to "$3FF_H$"

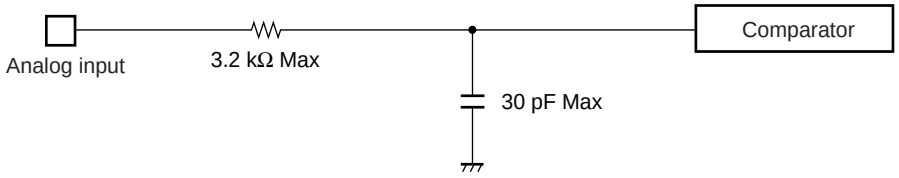
11.5.3 Notes on Using A/D Converter

Select the output impedance value for the external circuit of analog input according to the following conditions, :

- Output impedance values of the external circuit of 15 kΩ or lower are recommended.
- When capacitors are connected to external pins, the capacitance of several thousand times the internal capacitor value is recommended to minimized the effect of voltage distribution between the external capacitor and internal capacitor.

Note : When the output impedance of the external circuit is too high, the sampling period for analog voltages may not be sufficient (sampling period = 4.00 μs @machine clock of 16 MHz) .

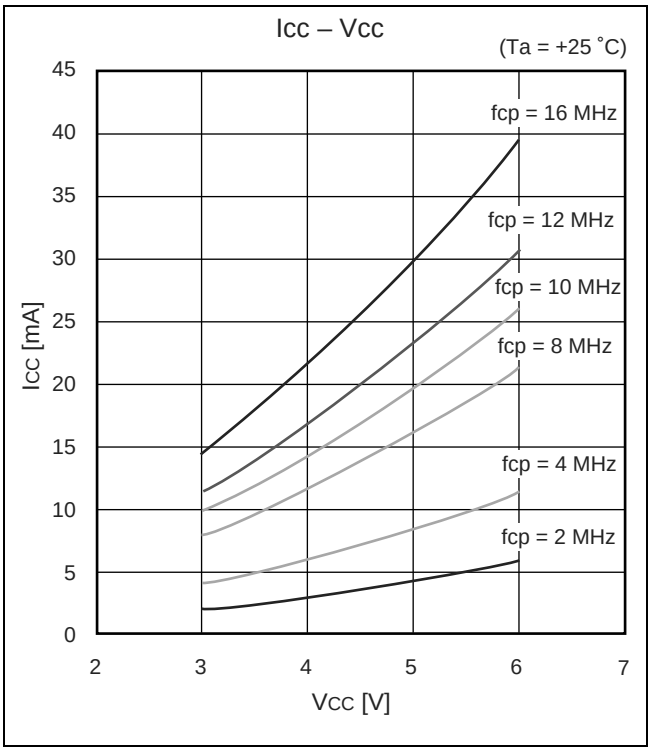
■ **Equipment of analog input circuit model**

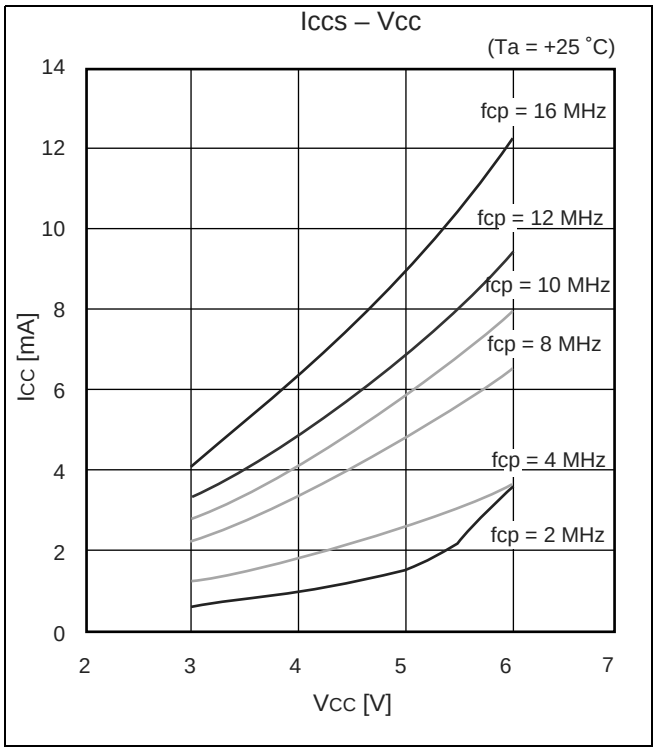


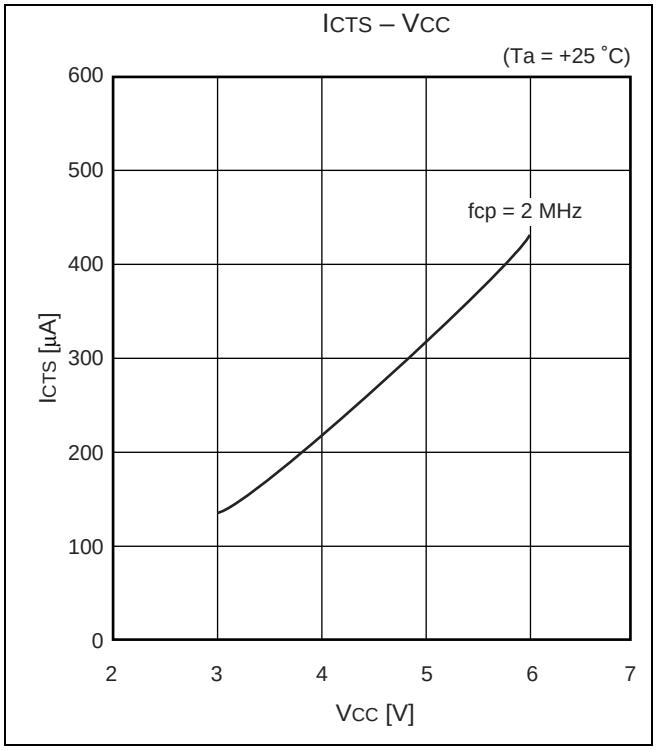
11.5.4 Error

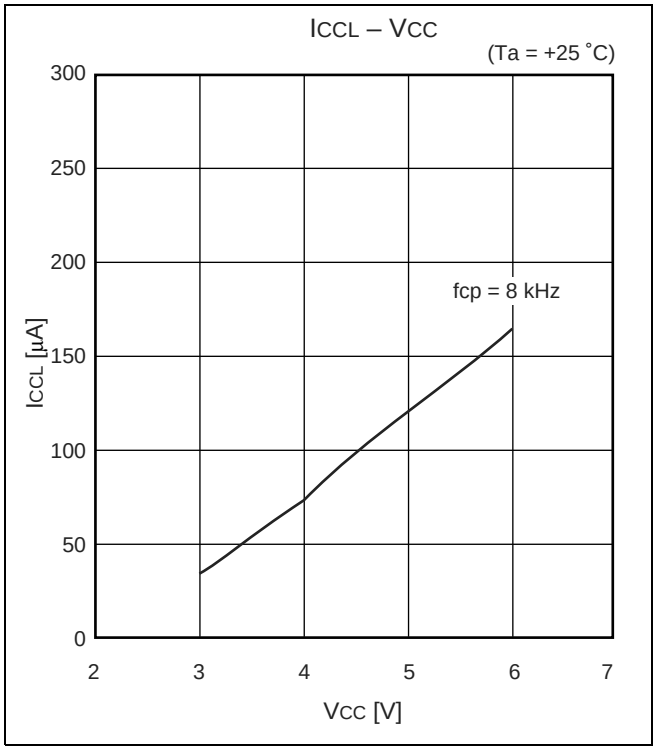
The smaller the | AVRH − AVRL |, the greater the error would become relatively.

■ Power supply current (MB90F549G)









15. Major Changes

Spansion Publication Number: DS07-13703-7E

Section	Change Results
■ PRODUCT LINEUP	Changed the name in peripheral resource. 16-bit I/O Timer → 16-bit Free-run Timer
■ I/O CIRCUIT TYPE	Changed the name of input typ. Hysteresis → CMOS Hysteresis HYS → CMOS Hysteresis
■ BLOCK DIAGRAM	Changed the arrow direction of SOT1 signal at UART1(SCI). "← →" (input/output) → "←" (output)
■ I/O MAP	Changed the text of "Note".
■ INTERRUPT MAP	Changed the name of peripheral resource of the pin number: #19. I/O Timer → 16-bit Free-run Timer
■ ELECTRICAL CHARACTERISTICS 2. Recommended Conditions	Changed the remarks of "parameter: Power supply voltage".
3. DC Characteristics	Changed the maximum value of symbol : VILM of parameter: Input voltage. V_{CC} + 0.3 → V_{SS} + 0.3
	Added the following remarks for parameter : Pull-down resistance. Except Flash device
4. AC Characteristics (1) Clock Timing	Added the value when using an external clock in Oscillation frequency and Clock cycle time on (1) Clock Timing for parameter.
	Added the item of A/D converter operation range in figure of "■ Guaranteed PLL operation range"
(3) Reset and Hardware Standby Input Timing	Changed the following item. (3) Reset and Hardware Standby Input Timing Remarks: In sub-clock mode, sub-sleep mode, timer mode $2t_{CP}$ → $2t_{LCP}$
(4) Power On Reset	Changed as follows; Due to repetitive operation → Waiting time until power-on
5. A/D Converter	Changed the unit of Zero transition voltage and Full scale transition voltage. mV → V
■ ORDERING INFORMATION	Added the MB90F548GLPMC in Part Numbers.

NOTE: Please see "Document History" about later revised information.

Document History

Document Title: MB90F543G(S)/546G(S)/548G(S)/549G(S)/549G(S)/V540G/MB90543G(S)/547G(S)/548G(S)/F548GL(S) CMOS F2MC-16LX MB90540G/545G Series 16-bit Proprietary Microcontroller
Document Number: 002-07696

Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	—	AKIH	11/13/2008	Migrated to Cypress and assigned document number 002-07696. No change to document contents or format.
*A	5537115	AKIH	11/30/2016	Updated to Cypress template